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# 650V N-Channel Silicon Carbide Power MOSFET

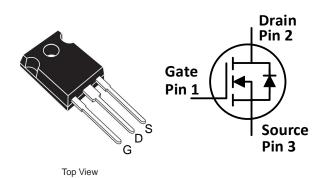
#### Features

- High blocking voltage with low on-resistance
- High speed switching with low capacitance
- High operating junction temperature capability
- Very fast and robust intrinsic body diode

### Applications

- EV chargers
- Server & Telecom PSU
- Solar inverters
- UPS
- High voltage DC/DC converters
- Switch mode power supplies

### Package



Part Number	Package
DTN70N65SC3	TO247-3

### **Absolute Maximum Ratings** (Tc=25°C unless otherwise specified)

Symbol	Parameter	Value	Un	Test Conditions	Note	
			it			
V <sub>DS</sub>	Drain-Source voltage	650	V	V <sub>GS</sub> =0V, I₀=100µA		
V <sub>GSmax</sub> (DC)	Maximum DC voltage	-5 to 22	V	Static (DC)		
V <sub>GSmax</sub> (Spike)	Maximum spike voltage	-10 to 25	V	<1% duty cycle, and pulse width<200ns		
V <sub>GSon</sub>	Recommended turn-on voltage	20±0.5	V			
V <sub>GSoff</sub>	Recommended turn-off voltage	-3.5 to -2	V			
	Drain current (continuous)	72	А	V <sub>GS</sub> =20V, T <sub>C</sub> =25°C	- Fig. 21	
D		58	А	V <sub>GS</sub> =20V, T <sub>C</sub> =100°C		
I <sub>DM</sub>	Drain current (pulsed)	180	А	Pulse width limited by SOA	Fig. 24	
P <sub>TOT</sub>	Total power dissipation	348	W	T <sub>c</sub> =25°C	Fig. 22	
T <sub>stg</sub>	Storage temperature range	-55 to 175	°C			
٦	Operating junction temperature	-55 to 175	°C			
Τι	Solder Temperature	260	°C	wave soldering only allowed at leads, 1.6mm from case for 10 s		

### **Thermal Data**

Symbol	Parameter	Value	Unit	Note
R <sub>θ(J-C)</sub>	Thermal Resistance from Junction to Case	0.431	°C/W	Fig. 23

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# Electrical Characteristics (Tc=25°C unless otherwise specified)

Symbol	Parameter	Value			Unit	Test Conditions	Note
		Min.	Тур.	Max.			l
Idss	Zero gate voltage drain current		3	100	μA	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V	
GSS	Gate leakage current			±100	nA	V <sub>DS</sub> =0V, V <sub>GS</sub> =-5~20V	
		1.8	3.2	5	V	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =6.1mA	
$V_{\text{TH}}$	Gate threshold voltage		2.2			V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =6.1mA @ T <sub>c</sub> =175°C	Fig. 8, 9
D	Static drain-source on-		40	55	mΩ	V <sub>GS</sub> =20V, I <sub>D</sub> =20A @T <sub>J</sub> =25°C	Fig. 4, 5, 6,
Ron	resistance		53		mΩ	V <sub>GS</sub> =20V, I <sub>D</sub> =20A @T <sub>J</sub> =175°C	7
Ciss	Input capacitance		2692		рF		Fig. 16
$C_{\text{oss}}$	Output capacitance		179		рF		
$C_{rss}$	Reverse transfer capacitance		10.8		рF	V <sub>DS</sub> =600V, V <sub>GS</sub> =0V, f=1MHz, V <sub>AC</sub> =25mV	
Eoss	Coss stored energy		35.6		μJ		Fig. 17
Qg	Total gate charge		110.8		nC	(-400)(-200)	Fig. 18
$Q_{\text{gs}}$	Gate-source charge		26.8		nC	$V_{DS}$ =400V, $I_{D}$ =20A, $V_{GS}$ =-5 to 20V	
$Q_{\text{gd}}$	Gate-drain charge		35.7		nC	V <sub>GS</sub> =-5 tO 20V	
Rg	Gate input resistance		2		Ω	f=1MHz	
Eon	Turn-on switching energy		289.1		μJ		
EOFF	Turn-off switching energy		117.1		μJ	V <sub>DS</sub> =400V, I <sub>D</sub> =30A,	Fig. 19, 20
t <sub>d(on)</sub>	Turn-on delay time		24.7			V <sub>GS</sub> =-2 to 20V,	
tr	Rise time		20.3		- DS	$R_{G(ext)}=3.3\Omega$ ,	
$t_{d(off)}$	Turn-off delay time		12.4		ns	L=450µH	
tr	Fall time		29.6				

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# Reverse Diode Characteristics (Tc=25°C unless otherwise specified)

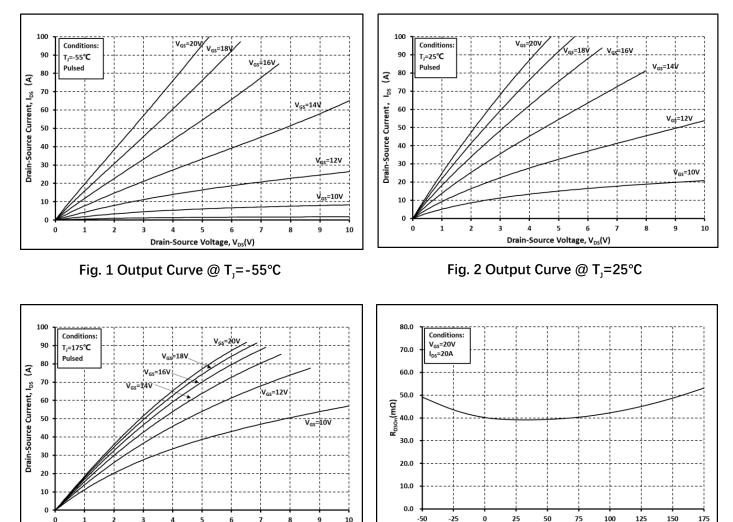
Symbol	Parameter	Value			Unit	Test Conditions	Note
		Min.	Тур.	Max.			
			4.0		V	I <sub>SD</sub> =20A, V <sub>GS</sub> =0V	Fig. 10,
$V_{\text{SD}}$	Diode forward voltage		3.6		V	I <sub>SD</sub> =20A, V <sub>GS</sub> =0V, T <sub>J</sub> =175°C	11, 12
trr	Reverse recovery time		23		ns	$V_{GS} = -2V/+20V,$	
Qrr	Reverse recovery charge		161		nC	I <sub>SD</sub> =30A, V <sub>R</sub> =400V, di/dt=1700A/us,	
I <sub>RRM</sub>	Peak reverse recovery current		10.4		А	R <sub>G(ext)</sub> =3.3Ω L=450μH	



0

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### **Typical Performance (curves)**



9

10

-50

0

25

Fig. 3 Output Curve @ T<sub>1</sub>=175°C

5

Drain-Source Voltage, V<sub>DS</sub>(V)

6

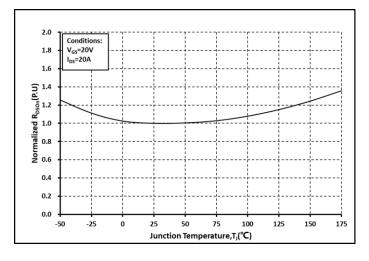


Fig. 5 Normalized Ron vs. Temperature

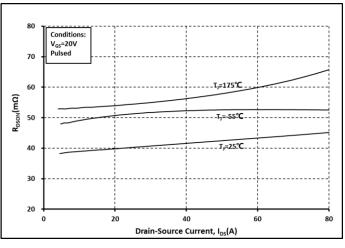
Fig. 4 Ron vs. Temperature

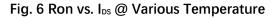
50

Junction Temperature,T,(°C)

75

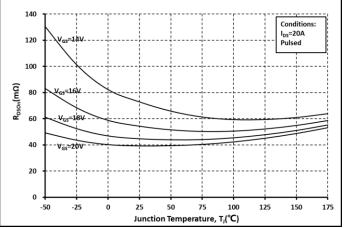
100





175

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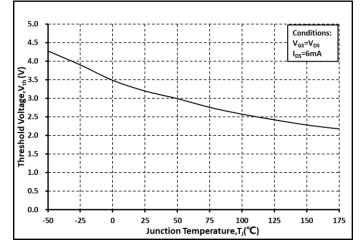


Fig. 9 Threshold Voltage vs. Temperature

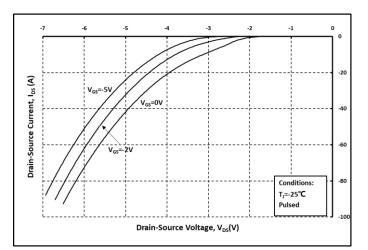


Fig. 11 Body Diode Curves @  $T_3=25^{\circ}C$ 

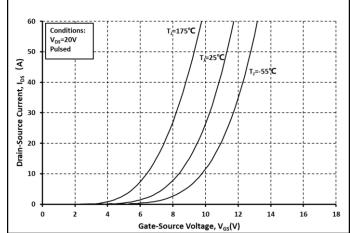


Fig. 8 Transfer Curves @ Various Temperature

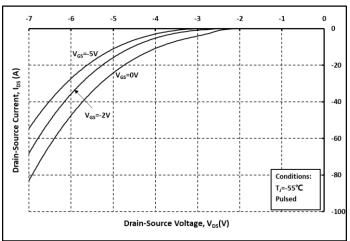


Fig. 10 Body Diode Curves @ T<sub>J</sub>=-55°C

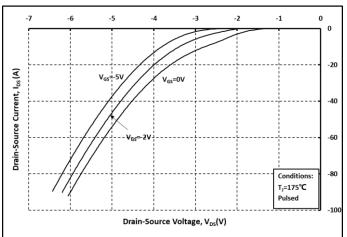


Fig. 12 Body Diode Curves @ T<sub>1</sub>=175°C



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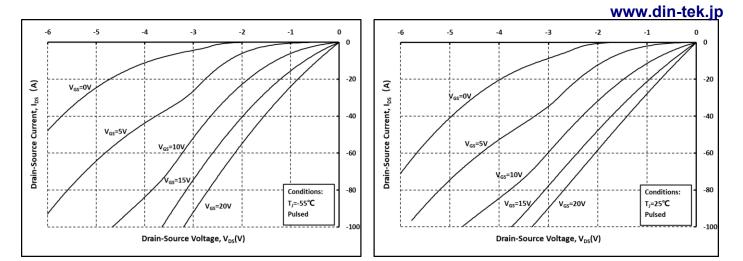


Fig. 13 3<sup>rd</sup> Quadrant Curves @ T<sub>J</sub>=-55°C



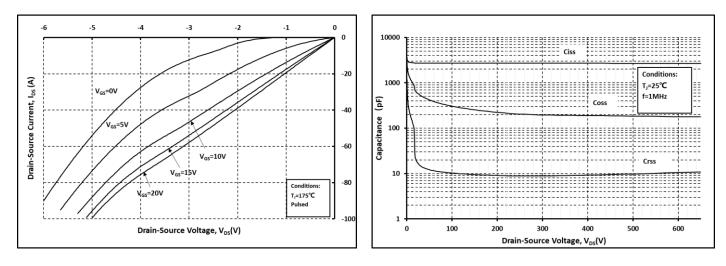


Fig. 15 3<sup>rd</sup> Quadrant Curves @ T<sub>J</sub>=175°C

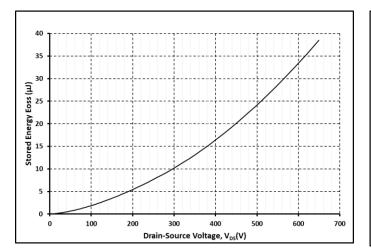


Fig. 17 Output Capacitor Stored Energy

Fig. 16 Capacitance vs. V<sub>DS</sub>

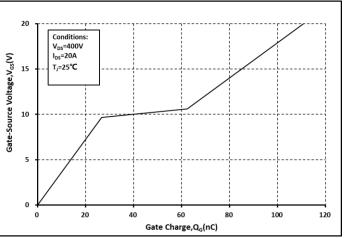
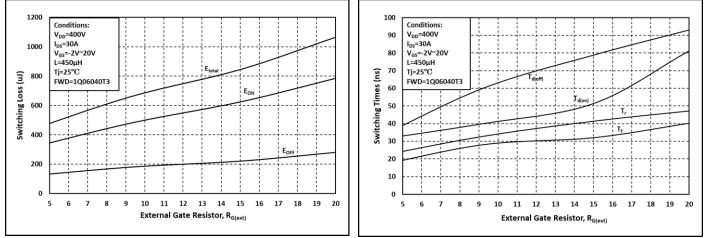


Fig. 18 Gate Charge Characteristics

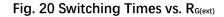


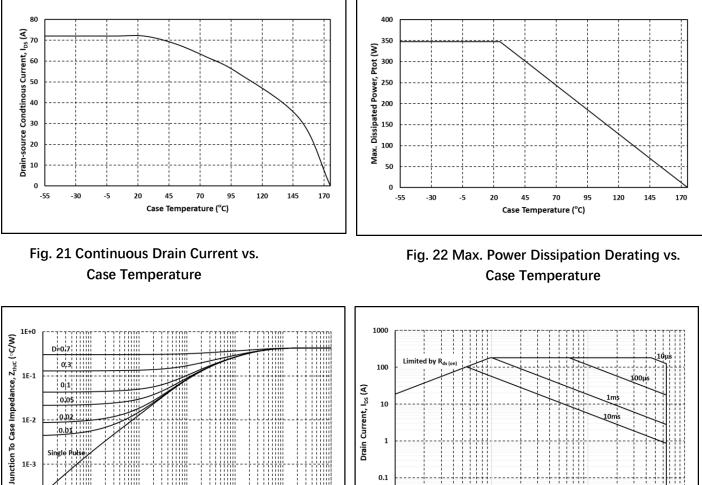
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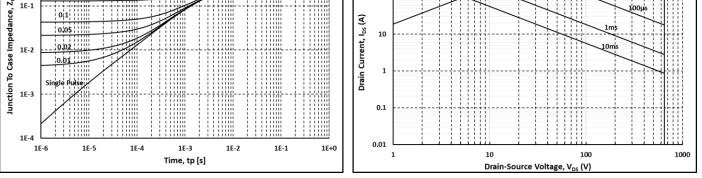
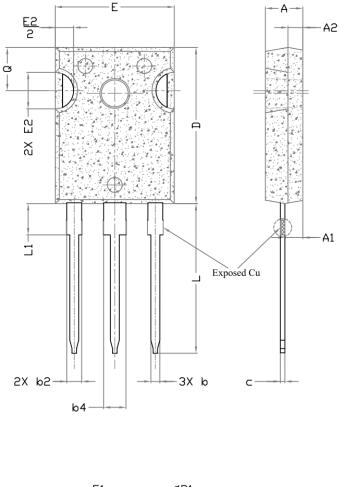


Fig. 23 Thermal Impedance

Fig. 24 Safe Operating Area

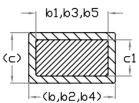


## Package Dimensions



	-E1	∕−øP1
2X e		
2X e		

	DIMENSIONS				
SYMBOL	MIN.	NOM.	MAX.	NOTES	
А	4.83	5.02	5.21		
A1	2.29	2.41	2.55		
A2	1.50	2.00	2.49		
b	1.12	1.20	1.33		
b1	1.12	1.20	1.28		
b2	1.91	2.00	2.39	6	
b3	1.91	2.00	2.34		
b4	2.87	3.00	3.22	6, 8	
b5	2.87	3.00	3.18		
с	0.55	0.60	0.69	6	
c1	0.55	0.60	0.65		
D	20.80	20.95	21.10	4	
D1	16.25	16.55	17.65	5	
D2	0.51	1.19	1.35		
E	15.75	15.94	16.13	4	
E1	13.46	14.02	14.16	5	
E2	4.32	4.91	5.49	3	
е					
L	19.81	20.07	20.32		
L1	4.10	4.19	4.40	6	
ØP	3.56	3.61	3.65	7	
ØP1					
Q	5.39	5.79	6.20		
S	6.04	6.17	6.30		



Section C--C,D--D,E-E

#### Note:

- 1. Package Reference: JEDEC TO247, Variation AD
- 2. All Dimensions are in mm
- 3. Slot Required, Notch May Be Rounded
- 4. Dimension D&E Do Not Include Mold Flash

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